



Product Change Notification

Change Notification #: 114732 - 00
Change Title: Intel® Server System R2308WTTYSR
PCN 114732 - 00
Product Design, DIMM connector change
Date of Publication: July 8, 2016

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

| | |
|---|----------------------|
| Date Customer Must be Ready to Receive Post-Conversion Material: | July 11, 2016 |
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Description of Change to the Customer:

Intel is implementing the following change on the Intel® Server System R2308WTTYSR:

- Replaced DIMM connector to increase gold plating thickness from 15u” to 30u” for higher durability

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

| Product Code | MM# | Pre TA# | Post TA# | Pre-PBA | Post-PBA |
|--------------|--------|------------|------------|------------|------------|
| R2308WTTYSR | 943829 | J11493-003 | J11493-004 | G92187-366 | G92187-367 |

PCN Revision History:

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| Date of Revision: July 8, 2016 | Revision Number: 00 | Reason: Originally Published PCN |
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#114732 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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